

DATA SHEET

FBL2041

FBL2041I

3.3V BTL 7-bit Futurebus+ transceiver
(standard A-port)

Product specification

Supersedes data of 1998 May 11

IC23 Data Handbook

1999 Apr 27

3.3V BTL 7-bit Futurebus+ transceiver (standard A-port)

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FEATURES

- 7-bit BTL transceiver
- Separate I/O on TTL A-port
- Inverting
- Three separate pairs of driver enables in a 1 bit, 3 bit, 3 bit arrangement
- Drives heavily loaded backplanes with equivalent load impedances down to 10Ω.
- High drive 100mA BTL open collector drivers on B-port
- Allows incident wave switching in heavily loaded backplane buses
- Reduced BTL voltage swing produces less noise and reduces power consumption
- Built-in precision band-gap reference provides accurate receiver thresholds and improved noise immunity
- Compatible with IEEE Futurebus+ or proprietary BTL backplanes
- Controlled output ramp and multiple GND pins minimize ground bounce
- Each BTL driver has a dedicated Bus GND for a signal return
- Glitch-free power up/power down operation
- Low I_{CC} current
- Tight output skew
- Supports live insertion
- Pins for the optional JTAG boundary scan function are provided
- High density packaging in plastic Quad Flatpack
- 5V compatible I/O on A-port
- Industrial temperature range option available as FBL2041I

DESCRIPTION

The FBL2041/FBL2041I is a 7-bit bidirectional BTL transceiver and is intended to provide the electrical interface to a high performance wired-OR bus. The FBL2041 is an inverting transceiver.

The B-port drivers are Low-capacitance open collectors with controlled ramp and are designed to sink 100mA. Precision band gap references on the B-port insure very good noise margins by limiting the switching threshold to a narrow region centered at 1.55V.

The FBL2041/FBL2041I is pin and function compatible with FB2041 but operates at a 3.3V supply voltage, greatly reducing power consumption.

The B-port interfaces to "Backplane Transceiver Logic" (See the IEEE 1194.1 BTL standard). BTL features low power consumption by reducing voltage swing (1Vp-p, between 1V and 2V) and reduced capacitive loading by placing an internal series diode on the drivers. BTL also provides incident wave switching, a necessity for high performance backplanes.

There are three separate pairs of driver enables in a 1 bit, 3 bit, 3 bit arrangement. The TTL/BTL output drivers for bit 0 are enabled with $OEA1/\overline{OEB1}$, output drivers for bits 1–2–3 are enabled with $OEA2/\overline{OEB2}$ and output drivers for bits 4–5–6 are enabled with $OEA3/\overline{OEB3}$.

The A-port operates at TTL levels with separate I/O. The 3-state A-port drivers are enabled when OEA_n goes High after an extra 6ns delay which is built in to provide a break-before-make function. When OEA_n goes Low, A-port drivers become High impedance without any extra delay. During power on/off cycles, the A-port drivers are held in a High impedance state when V_{CC} is below 1.3V.

The B-port has an output enable, $OEB0$, which affects all seven drivers. When $OEB0$ is High and \overline{OEBn} is Low the output driver will be enabled. When $OEB0$ is Low or if \overline{OEBn} is High, the B-port drivers will be inactive and at the level of the backplane signal.

To support live insertion, $OEB0$ is held Low during power on/off cycles to insure glitch free B port drivers. Proper bias for B port drivers during live insertion is provided by the BIAS V pin when at a 3.3V level while V_{CC} is Low. If live insertion is not a requirement, the BIAS V pin should be tied to a V_{CC} pin.

The LOGIC GND and BUS GND pins are isolated in the package to minimize noise coupling between the BTL and TTL sides. These pins should be tied to a common ground external to the package.

Each BTL driver has an associated BUS GND pin that acts as a signal return path and these BUS GND pins are internally isolated from each other. In the event of a ground return fault, a "hard" signal failure occurs instead of a pattern dependent error that may be very infrequent and impossible to trouble-shoot.

JTAG boundary scan functionality is provided as an option with signals TMS, TCK, TDI and TDO. When this option is not present, TMS and TCK are no-connects (no bond wires) and TDI and TDO are shorted together internally.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay AIn to $B\bar{n}$	4.2 3.5	ns
t_{PLH} t_{PHL}	Propagation delay $B\bar{n}$ to AOn	4.8 4.9	ns
C_{OB}	Output capacitance ($B\bar{0}$ - $B\bar{6}$ only)	6	pF
I_{OL}	Output current ($B\bar{0}$ - $B\bar{6}$ only)	100	mA
I_{CC}	Supply Current	Standby	5.2
		AIn to $B\bar{n}$ (outputs Low or High)	3.2
		$B\bar{n}$ to AOn (outputs Low)	13.5
		$B\bar{n}$ to AOn (outputs High)	10.7

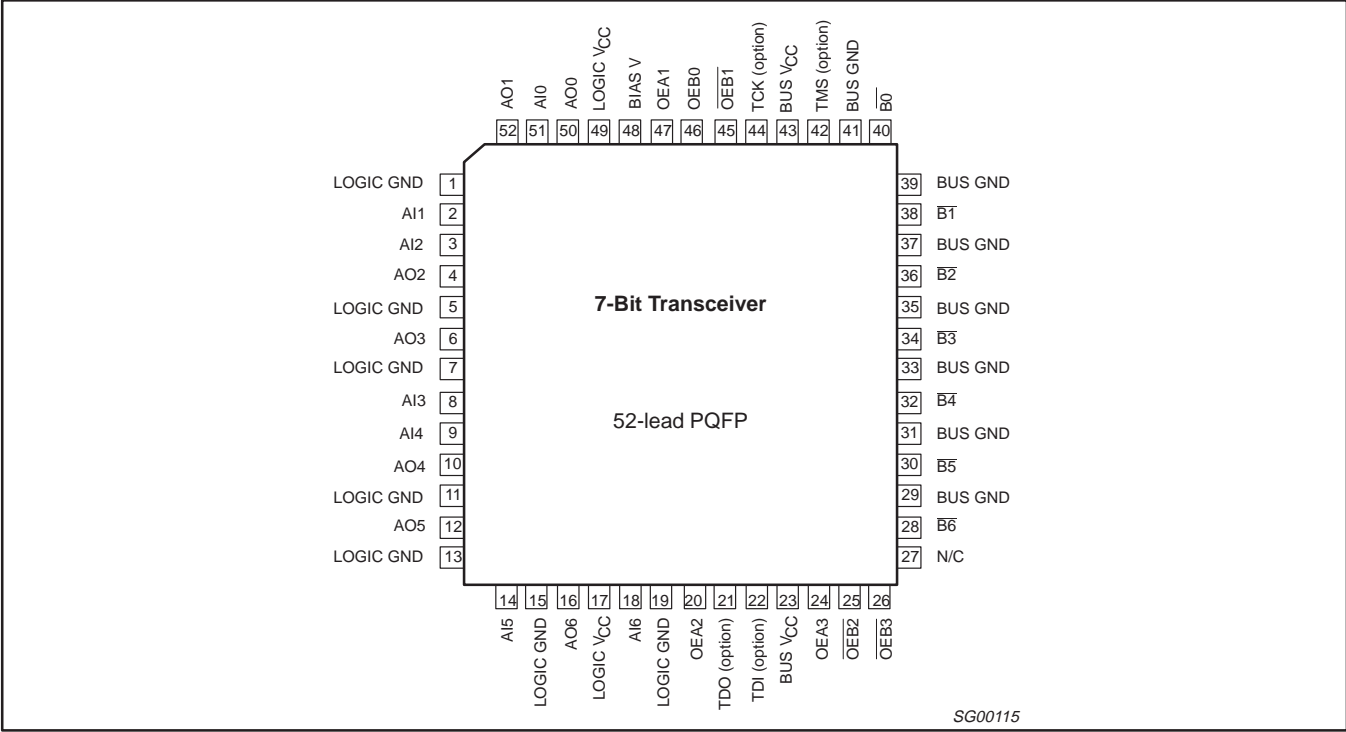
ORDERING INFORMATION

PACKAGE	COMMERCIAL RANGE $V_{CC} = 3.3V \pm 10\%$; $T_{amb} = 0$ to $+70^\circ C$	INDUSTRIAL RANGE $V_{CC} = 3.3V \pm 10\%$; $T_{amb} = -40$ to $+85^\circ C$	DWG No.
52-pin Plastic Quad Flatpack	FBL2041 BB	FBL2041I BB	SOT379-1

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PIN CONFIGURATION



PIN DESCRIPTION

SYMBOL	PIN NUMBER	TYPE	NAME AND FUNCTION
AI0 – AI6	51, 2, 3, 8, 9, 14, 18	Input	Data inputs (TTL)
AO0 – AO6	50, 52, 4, 6, 10, 12, 16	Output	3-State outputs (TTL)
B0 – B6	40, 38, 36, 34, 32, 30, 28	I/O	Data inputs/Open Collector outputs, High current drive (BTL)
OEB0	46	Input	Enables the Bn outputs when High
OEB1	45	Input	Enables the B0 output when Low
OEB2	25	Input	Enables the B1 – B3 outputs when Low
OEB3	26	Input	Enables the B4 – B6 outputs when Low
OEA1	47	Input	Enables the A0 outputs when High
OEA2	20	Input	Enables the A1 – A3 outputs when High
OEA3	24	Input	Enables the A4 – A6 outputs when High
BUS GND	41, 39, 37, 35, 33, 31, 29	GND	Bus ground (0V)
LOGIC GND	1, 5, 7, 11, 13, 15, 19	GND	Logic ground (0V)
BUS VCC	23, 43	Power	Positive supply voltage
LOGIC VCC	17, 49	Power	Positive supply voltage BAND GAP
BIAS V	48	Power	Positive supply voltage
TMS	42	Input	Test Mode Select (no-connect)
TCK	44	Input	Test Clock (no-connect)
TDI	22	Input	Test Data In (shorted to TDO)
TDO	21	Output	Test Data Out (TDI)
N/C	27	—	Not connected

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FUNCTION TABLE

MODE	INPUTS									OUTPUTS	
	AIn	Bn*	OEB0	OEB1	OEB2	OEB3	OEA1	OEA2	OEA3	AOn	Bn*
AIn to Bn	L	—	H	L	L	L	L	L	L	Z	H**
	H	—	H	L	L	L	L	L	L	Z	L
	L	—	H	L	L	L	H	H	H	L	H**
	H	—	H	L	L	L	H	H	H	H	L
AI0 to B0	L	—	H	L	X	X	L	L	L	Z	H**
	H	—	H	L	X	X	L	L	L	Z	L
	L	—	H	L	X	X	H	H	H	L	H**
	H	—	H	L	X	X	H	H	H	H	L
AI1 – AI3 to B1 – B3	L	—	H	X	L	X	L	L	L	Z	H**
	H	—	H	X	L	X	L	L	L	Z	L
	L	—	H	X	L	X	H	H	H	L	H**
	H	—	H	X	L	X	H	H	H	H	L
AI4 – AI6 to B4 – B6	L	—	H	X	X	L	L	L	L	Z	H**
	H	—	H	X	X	L	L	L	L	Z	L
	L	—	H	X	X	L	H	H	H	L	H**
	H	—	H	X	X	L	H	H	H	H	L
Disable Bn outputs	X	X	L	X	X	X	X	X	X	X	H**
	X	X	X	H	H	H	X	X	X	X	H**
Disable B0 outputs	X	X	H	H	X	X	X	X	X	X	H**
Disable B1 – B3 outputs	X	X	H	X	H	X	X	X	X	X	H**
Disable B4 – B6 outputs	X	X	H	X	X	H	X	X	X	X	H**
Bn to AOn	X	L	L	X	X	X	H	H	H	H	Input
	X	H	L	X	X	X	H	H	H	L	Input
	X	L	X	H	H	H	H	H	H	H	Input
	X	H	X	H	H	H	H	H	H	L	Input
B0 to AO0	X	L	L	X	X	X	H	X	X	H	Input
	X	H	L	X	X	X	H	X	X	L	Input
	X	L	X	H	H	H	H	X	X	H	Input
	X	H	X	H	H	H	H	X	X	L	Input
B1 – B3 to AO1 – AO3	X	L	L	X	X	X	X	H	X	H	Input
	X	H	L	X	X	X	X	H	X	L	Input
	X	L	X	H	H	H	X	H	X	H	Input
	X	H	X	H	H	H	X	H	X	L	Input
B4 – B6 to AO4 – AO6	X	L	L	X	X	X	X	X	H	H	Input
	X	H	L	X	X	X	X	X	H	L	Input
	X	L	X	H	H	H	X	X	H	H	Input
	X	H	X	H	H	H	X	X	H	L	Input
Disable AOn outputs	X	X	X	X	X	X	L	L	L	Z	X
Disable AO0 outputs	X	X	X	X	X	X	L	X	X	Z	X
Disable AO1 – AO3 outputs	X	X	X	X	X	X	X	L	X	Z	X
Disable AO4 – AO6 outputs	X	X	X	X	X	X	X	X	L	Z	X

NOTES:

H = High voltage level

L = Low voltage level

X = Don't care

Z = High-impedance (OFF) state

— = Input not externally driven

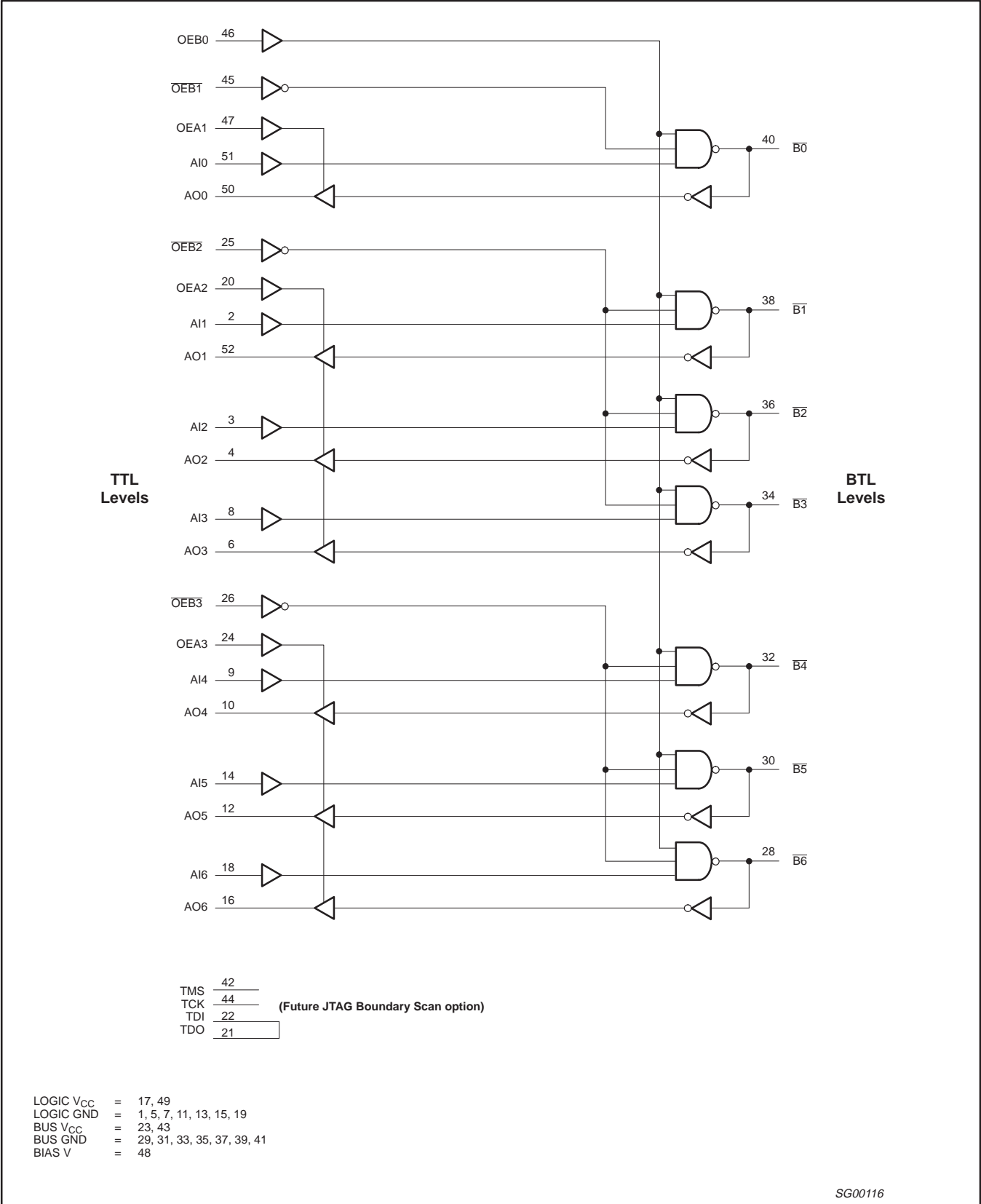
H** = Goes to level of pull-up voltage

B* = Precaution should be taken to ensure B inputs do not float. If they do, they are equal to Low state.

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LOGIC DIAGRAM



3.3V BTL 7-bit Futurebus+ transceiver (standard A-port)

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FBL2041I**ABSOLUTE MAXIMUM RATINGS**

Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +4.6	V
V_{IN}	Input voltage	A10 – A16, OE \overline{B} 0, \overline{OE} B \overline{n} , OEAn	-0.5 to +7.0	V
		B $\overline{0}$ – B $\overline{6}$	-0.5 to +3.5	
I_{IN}	Input current	$V_{IN} < 0$	-50	
V_{OUT}	Voltage applied to output in High output state		-0.5 to +7.0	V
I_{OUT}	Current applied to output in Low output state/High output state	AO0 – AO6	64, -64	mA
		B $\overline{0}$ – B $\overline{6}$	200	
T_{STG}	Storage temperature		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		COMMERCIAL LIMITS $V_{CC} = 3.3V \pm 10\%$; $T_{amb} = 0 \text{ to } +70^\circ\text{C}$			INDUSTRIAL LIMITS $V_{CC} = 3.3V \pm 10\%$; $T_{amb} = -40 \text{ to } +85^\circ\text{C}$			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{CC}	Supply voltage		3.0	3.3	3.6	3.0	3.3	3.6	V
V_{IH}	High-level input voltage	Except B $\overline{0}$ –B $\overline{6}$	2.0			2.0			V
		B $\overline{0}$ – B $\overline{6}$	1.62	1.55		1.62	1.55		
V_{IL}	Low-level input voltage	Except B $\overline{0}$ –B $\overline{6}$			0.8			0.8	V
		B $\overline{0}$ – B $\overline{6}$			1.47			1.47	
I_{IK}	Input clamp current				-18			-18	mA
I_{OH}	High-level output current	AO0 – AO6			-32			-32	mA
I_{OL}	Low-level output current	AO0 – AO6			+32			+32	mA
		B $\overline{0}$ – B $\overline{6}$			100			100	
C_{OB}	Output capacitance on B port			6	7		6	7	pF
T_{amb}	Operating free-air temperature range		0		+70	-40		+85	°C

LIVE INSERTION SPECIFICATIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	TYP	MAX	
V_{BIASV}	Bias pin voltage	Voltage difference between the Bias voltage and V_{CC} after the PCB is plugged in.	–	–	0.5	V
I_{BIASV}	Bias pin (I_{BIASV}) input DC current	$V_{CC} = 0 \text{ V}$, Bias $V = 3.6 \text{ V}$			1.2	mA
		$V_{CC} = 3.3 \text{ V}$, Bias $V = 3.6 \text{ V}$			10	μA
V_{Bn}	Bus voltage during prebias	B $\overline{0}$ – B $\overline{8} = 0 \text{ V}$, Bias $V = 3.3 \text{ V}$	1.62		2.1	V
I_{LM}	Fall current during prebias	B $\overline{0}$ – B $\overline{8} = 2 \text{ V}$, Bias $V = 1.3 \text{ to } 2.5 \text{ V}$			1	μA
I_{HM}	Rise current during prebias	B $\overline{0}$ – B $\overline{8} = 1 \text{ V}$, Bias $V = 3 \text{ to } 3.6 \text{ V}$	-1			μA
I_{Bn}^{PEAK}	Peak bus current during insertion	$V_{CC} = 0 \text{ to } 3.3 \text{ V}$, B $\overline{0}$ – B $\overline{8} = 0 \text{ to } 2.0 \text{ V}$, Bias $V = 2.7 \text{ to } 3.6 \text{ V}$, OE \overline{B} 0 = 0.8V, $t_r = 2 \text{ ns}$			10	mA
I_{OLOFF}	Power up current	$V_{CC} = 0 \text{ to } 3.3 \text{ V}$, OE \overline{B} 0 = 0.8V			100	μA
		$V_{CC} = 0 \text{ to } 1.2 \text{ V}$, OE \overline{B} 0 = 0 to 5V			100	
t_{GR}	Input glitch rejection	$V_{CC} = 3.3 \text{ V}$	1.0	1.35		ns

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range unless otherwise noted.

SYMBOL	PARAMETER		TEST CONDITIONS ¹	LIMITS			UNIT
				MIN	TYP ²	MAX	
I_{OH}	High level output current	$\overline{B0} - \overline{B6}$	$V_{CC} = \text{MAX}$, $V_{IL} = \text{MAX}$, $V_{OH} = 1.9\text{V}$			100	μA
I_{OFF}	Power-off output current	$\overline{B0} - \overline{B6}$	$V_{CC} = 0\text{V}$, $V_{IL} = \text{MAX}$, $V_{OH} = 1.9\text{V}$			100	μA
			$V_{CC} = 0\text{V}$, $V_{IL} = \text{MAX}$, $V_{OH} = 1.9\text{V}$ @ 85°C			300	μA
V_{OH}	High-level output voltage	AO0 – AO6 ³	$V_{CC} = \text{MIN to MAX}$; $I_{OH} = -100\mu\text{A}$	$V_{CC} - 0.2$			V
			$V_{CC} = \text{MIN}$; $I_{OH} = -8\text{mA}$	2.4			V
			$V_{CC} = \text{MIN}$; $I_{OH} = -32\text{mA}$	2.0			V
V_{OL}	Low-level output voltage	AO0 – AO6 ³	$V_{CC} = \text{MIN}$; $I_{OL} = 16\text{mA}$			0.4	V
			$V_{CC} = \text{MIN}$; $I_{OL} = 32\text{mA}$			0.5	V
		$\overline{B0} - \overline{B6}$	$V_{CC} = \text{MIN}$, $I_{OL} = 4\text{mA}$	0.5			V
			$V_{CC} = \text{MIN}$, $I_{OL} = 100\text{mA}$	0.75	1.0	1.20	V
V_{IK}	Input clamp voltage		$V_{CC} = \text{MIN}$, $I_I = I_{IK} = -18\text{mA}$		-0.85	-1.2	V
I_I	Input leakage current	Control pins	$V_{CC} = 3.6\text{V}$; $V_I = V_{CC}$ or GND			± 1.0	μA
		Control/ AI0 – AI6	$V_{CC} = 0\text{V}$ or 3.6V ; $V_I = 5.5\text{V}$			10	
		AI0 – AI6	$V_{CC} = 3.6\text{V}$; $V_I = V_{CC}$			1	
		Note 4	$V_{CC} = 3.6\text{V}$; $V_I = 0\text{V}$			-5	
I_{IH}	High-level input current	$\overline{B0} - \overline{B6}$	$V_{CC} = \text{MAX}$, $V_I = 1.9\text{V}$			100	μA
			$V_{CC} = \text{MAX}$, $V_I = 3.5\text{V}$, note 5	100			mA
			$V_{CC} = \text{MAX}$; $V_I = 3.75\text{V}$ @ -40°C	100			mA
I_{IL}	Low-level input current	$\overline{B0} - \overline{B6}$	$V_{CC} = \text{MAX}$, $V_I = 0.75\text{V}$			-100	μA
I_{OZH}	Off-state output current	AO0 – AO6	$V_{CC} = \text{MAX}$, $V_O = 3\text{V}$			5	μA
I_{OZL}	Off-state output current	AO0 – AO6	$V_{CC} = \text{MAX}$, $V_O = 0.5\text{V}$			-5	μA
I_{CC}	Supply current (total)	I_{CCZ}	$V_{CC} = \text{MAX}$		5.2	13.5	mA
		I_{CCB}	$V_{CC} = \text{MAX}$, outputs Low or High		3.2	9.0	
		I_{CCL}	$V_{CC} = \text{MAX}$, outputs Low		13.5	19.5	
		I_{CCH}	$V_{CC} = \text{MAX}$, outputs High		10.7	16.0	

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operation conditions for the applicable type.
- All typical values are at $V_{CC} = 3.3\text{V}$, $T_A = 25^\circ\text{C}$.
- Due to test equipment limitations, actual test conditions are $V_{IH} = 1.8\text{V}$ and $V_{IL} = 1.3\text{V}$ for the B side.
- Unused pins are at V_{CC} or GND.
- For B port input voltage between 3 and 5 volt; I_{IH} will be greater than 100mA but the part will continue to function normally (clamping circuit is active).

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AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	A PORT LIMITS								UNIT
			$T_{amb} = +25^{\circ}C$, $V_{CC} = 3.3V$, $C_L = 50pf$, $R_L = 500\Omega$			FBL2041 COMMERCIAL		FBL2041I INDUSTRIAL			
						$T_{amb} = 0 \text{ to } +70^{\circ}C$, $V_{CC} = 3.3V\pm10\%$, $C_L = 50pF$, $R_L = 500\Omega$		$T_{amb} = -40 \text{ to } +85^{\circ}C$, $V_{CC} = 3.3V\pm10\%$, $C_L = 50pF$, $R_L = 500\Omega$			
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
t_{PLH} t_{PHL}	Propagation delay, \overline{Bn} to AOn	Waveform 1, 2	3.9 4.0	4.8 4.9	5.8 6.0	3.7 3.8	6.4 6.7	2.8 2.7	6.9 7.0	ns	
t_{PZH} t_{PZL}	Output enable time, OEA to AOn	Waveform 4, 5	5.3 2.4	6.6 4.4	8.0 8.0	5.0 2.1	8.6 8.5	4.5 1.1	9.0 9.0	ns	
t_{PHZ} t_{PLZ}	Output disable time, OEA to AOn	Waveform 4, 5	3.5 2.3	4.8 3.1	6.0 3.9	3.4 2.2	6.5 4.3	2.7 1.4	7.0 4.7	ns	
t_{TLH} t_{THL}	Transition time, AOn Port (10% to 90% or 90% to 10%)	Test Circuit and Waveforms	0.7 0.5	1.8 1.6	3.0 2.0	0.7 0.5	3.0 2.0	0.7 0.5	3.0 2.0	ns	
$t_{SK(o)}$	Output skew between receivers in same package ¹	Waveform 3		0.7	1.5		1.5		1.5	ns	
SYMBOL	PARAMETER	TEST CONDITION	B PORT LIMITS								UNIT
			$T_{amb} = +25^{\circ}C$, $V_{CC} = 3.3V$, $C_D = 30pF$, $R_U = 9\Omega$			$T_{amb} = 0 \text{ to } +70^{\circ}C$, $V_{CC} = 3.3V\pm10\%$, $C_D = 30pF$, $R_U = 9\Omega$		$T_{amb} = -40 \text{ to } +85^{\circ}C$, $V_{CC} = 3.3V\pm10\%$, $C_D = 30pF$, $R_U = 9\Omega$			
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	3.3 2.7	4.2 3.5	5.2 4.5	2.9 2.5	6.0 5.0	1.8 1.7	6.7 5.6	ns	
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	4.0 3.4	4.9 4.3	5.8 5.3	3.6 3.1	6.6 6.0	2.8 2.5	7.1 6.4	ns	
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	4.2 2.9	5.1 3.8	6.1 4.7	3.9 2.6	6.9 5.5	2.9 1.9	7.3 6.0	ns	
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.2 0.4	2.4 0.9	3.0 1.5	1.2 0.4	3.0 1.5	1.2 0.4	3.0 1.5	ns	
$t_{SK(o)}$	Output skew between drivers in same package ¹	Waveform 3			1.5		1.5		1.5	ns	
SYMBOL	PARAMETER	TEST CONDITION	$R_U = 16.5\Omega$			$R_U = 16.5\Omega$		$R_U = 16.5\Omega$		UNIT	
t_{PLH} t_{PHL}	Propagation delay, AIn to \overline{Bn}	Waveform 1, 2	3.3 2.7	4.2 3.6	5.1 4.5	3.0 2.5	6.0 5.0	1.8 1.7	6.7 5.6	ns	
t_{PLH} t_{PHL}	Enable/disable time, OEB0 to \overline{Bn}	Waveform 2	4.0 3.4	4.9 4.3	5.8 5.3	3.6 3.1	6.6 6.0	2.7 2.5	7.1 6.4	ns	
t_{PLH} t_{PHL}	Enable/disable time, OEB1 to \overline{Bn}	Waveform 1	4.2 2.9	5.1 3.8	6.1 4.7	3.9 2.6	6.8 5.5	3.0 1.9	7.3 6.0	ns	
t_{TLH} t_{THL}	Transition time, \overline{Bn} Port (1.3V to 1.8V)	Test Circuit and Waveforms	1.2 0.4	2.4 0.9	3.0 1.5	1.2 0.4	3.0 1.5	1.2 0.4	3.0 1.5	ns	
$t_{SK(o)}$	Output skew between drivers in same package ¹	Waveform 3			1.5		1.5		1.5	ns	

NOTES:

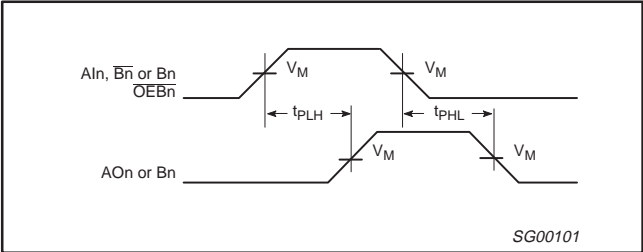
- $|t_{PNactual} - t_{PMactual}|$ for any data input to output path compared to any other data input to output path where N and M are either LH or HL. Skew times are valid only under same test conditions (temperature, V_{CC} , loading, etc.).

3.3V BTL 7-bit Futurebus+ transceiver (standard A-port)

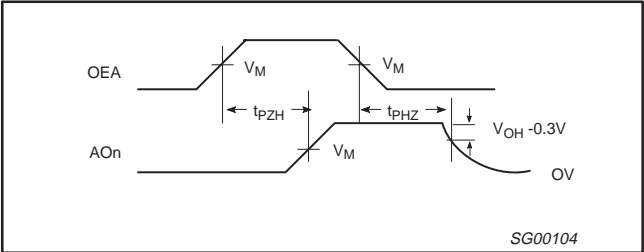
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AC WAVEFORMS

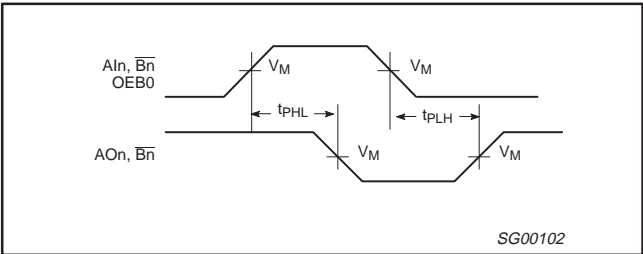
$V_M = 1.55V$ for \overline{Bn} , $V_M = 1.5V$ for all others.



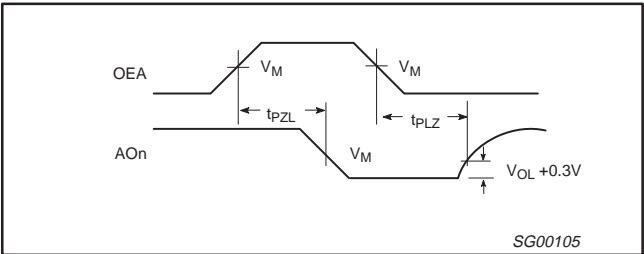
Waveform 1. Propagation Delay for Data or Output Enable to Output



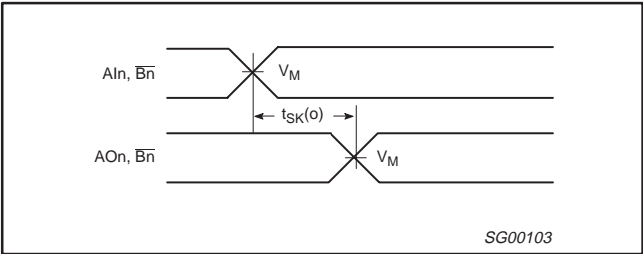
Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 2. Propagation Delay for Data or Output Enable to Output



Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

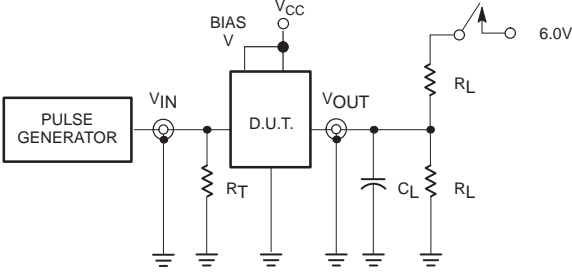


Waveform 3. Output Skews

3.3V BTL 7-bit Futurebus+ transceiver (standard A-port)

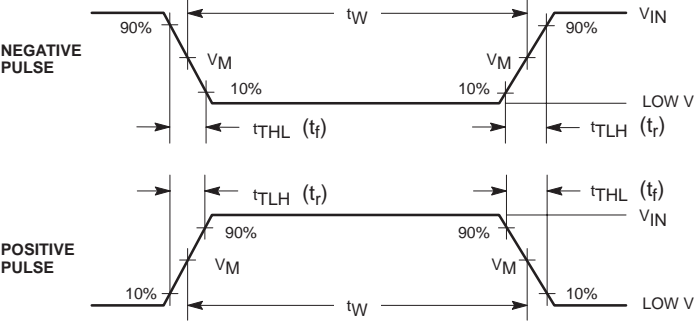
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TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs on A Port

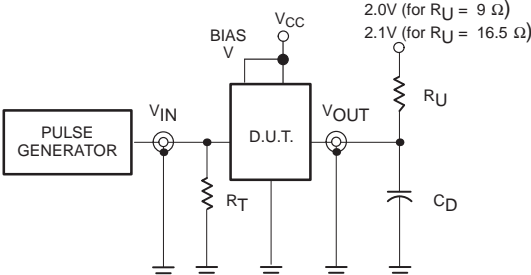
The circuit shows a Pulse Generator connected to the input V_{IN} of a D.U.T. (Device Under Test). The input line has a termination resistor R_T to ground. The output V_{OUT} is connected to a load resistor R_L in series with a switch, which is then connected to a 6.0V supply. The output also has a load capacitor C_L and a resistor R_L to ground. The D.U.T. is biased with V_{CC} and V_{BIAS} .



Input Pulse Definitions

The diagrams show the timing for negative and positive pulses. For a negative pulse, the signal transitions from V_{IN} (90%) to V_M (10%) with a delay $t_{THL} (t_f)$, remains at V_M for a width t_W , and then transitions back to V_{IN} (90%) with a delay $t_{TLH} (t_r)$. For a positive pulse, the signal transitions from $LOW V$ (10%) to V_M (90%) with a delay $t_{TLH} (t_r)$, remains at V_M for a width t_W , and then transitions back to $LOW V$ (10%) with a delay $t_{THL} (t_f)$. The voltage V_M is defined as 1.55V for \overline{Bn} and 1.5V for all other inputs.

TEST	SWITCH
t_{PLH}, t_{PHL}	OPEN
t_{PLZ}, t_{PZL}	CLOSED
t_{PHZ}, t_{PZH}	GND



Test Circuit for Outputs on B Port

The circuit shows a Pulse Generator connected to the input V_{IN} of a D.U.T. The input line has a termination resistor R_T to ground. The output V_{OUT} is connected to a pull-up resistor R_U to a supply voltage (2.0V for $R_U = 9\Omega$ or 2.1V for $R_U = 16.5\Omega$) and a load capacitor C_D to ground. The D.U.T. is biased with V_{CC} and V_{BIAS} .

Family FB+	INPUT PULSE REQUIREMENTS					
	Amplitude	Low V	Rep. Rate	t_W	t_{TLH}	t_{THL}
A Port	3.0V	0.0V	1MHz	500ns	2.5ns	2.5ns
B Port	2.0V	1.0V	1MHz	500ns	2.5ns	2.5ns

DEFINITIONS:

R_L = Load Resistor; see AC CHARACTERISTICS for value.
 C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.
 C_D = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
 R_U = Pull up resistor; see AC CHARACTERISTICS for value.

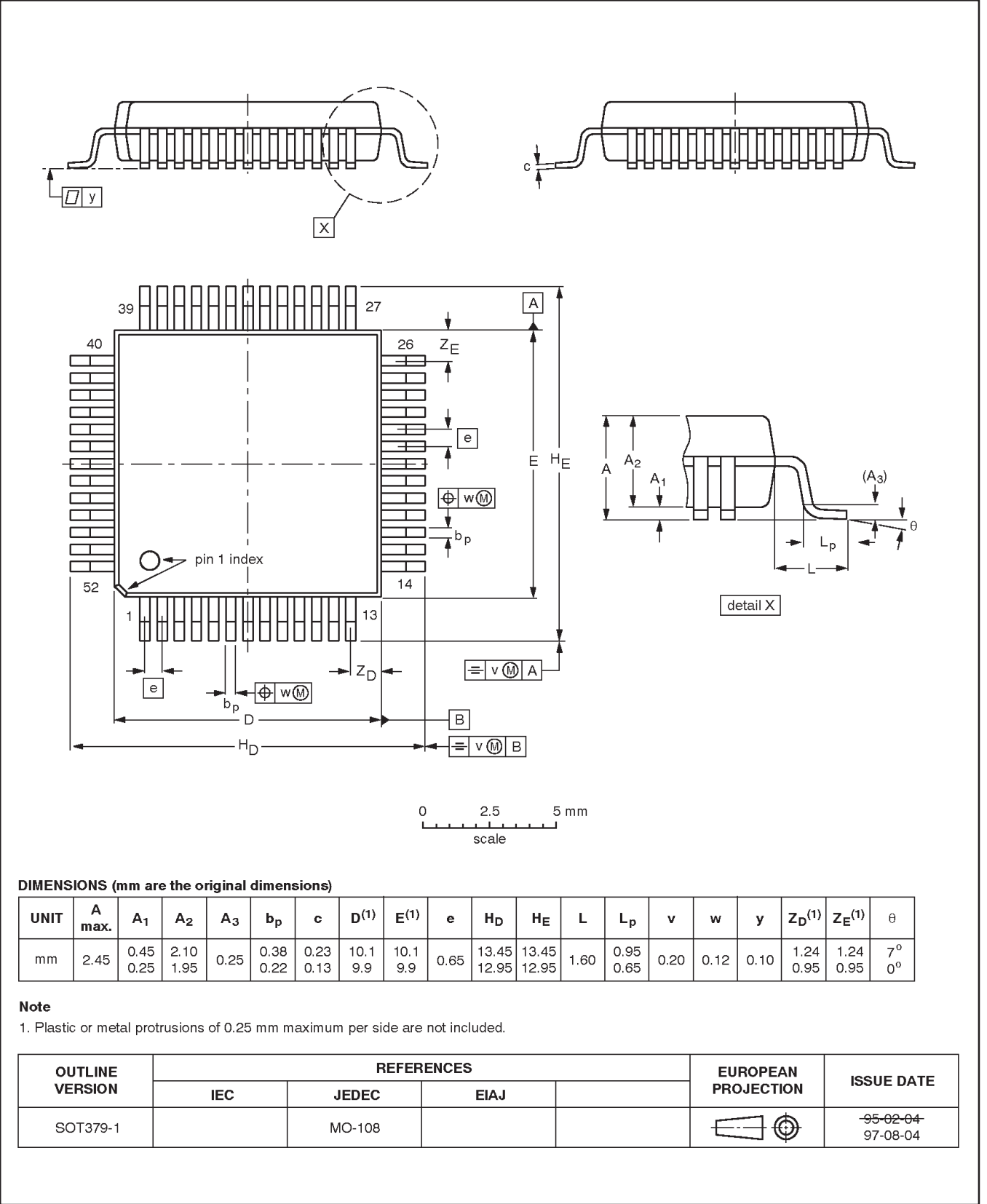
SG00090

3.3V BTL 7-bit Futurebus+ transceiver (standard A port)

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QFP52: plastic quad flat package; 52 leads (lead length 1.6 mm); body 10 x 10 x 2.0 mm

SOT379-1



3.3V BTL 7-bit Futurebus+ transceiver (standard A port)

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Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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